

Vishay High Power Products

FlipKY® Chip Scale Package Schottky Barrier Rectifier, 0.5 A



PRODUCT SUMMARY I_{F(AV)} 0.5 A V_B 40 V

FEATURES

- Ultra low V_F to footprint area
- Very low profile (< 0.6 mm)
- · Low thermal resistance
- · Supplied tested and on tape and reel



APPLICATIONS

- · Reverse polarity protection
- · Current steering
- · Freewheeling
- Flyback
- Oring

DESCRIPTION

Vishay's FlipKY® product family utilizes wafer level chip scale packaging to deliver Schottky diodes with the lowest V_F to PCB footprint area in industry. The three pad 0.9 mm x 1.2 mm devices can deliver up to 0.5 A and occupy only 1.08 mm² of board space. The anode and cathode connections are made through solder bump pads on one side of the silicon enabling designers to strategically place the diodes on the PCB. This design not only minimizes board space but also reduces thermal resistance and inductance, which can improve overall circuit efficiency.

Typical applications include hand-held, portable equipment such as cell phones, MP3 players, bluetooth, GPS, PDAs, and portable hard disk drives where space savings and performance are crucial.

MAJOR RATINGS AND CHARACTERISTICS					
SYMBOL	CHARACTERISTICS	MAX.	UNITS		
V _{RRM}		40	V		
I _{F(AV)}	Rectangular waveform	0.5	Δ.		
I _{FSM}		190	A		
V _F	0.5 Apk, T _J = 125 °C	0.42	V		
T _J		- 55 to 150	°C		

VOLTAGE RATINGS				
PARAMETER	SYMBOL	FCSP05H40TR	UNITS	
Maximum DC reverse voltage	V_{R}	40	V	
Maximum working peak reverse voltage	V_{RWM}	40	V	

FCSP05H40TR

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ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average forward current	average forward current I _{F(AV)} 50 % duty cycle at T _{PCB} = 114 °C, rectangular waveform		0.5		
Maximum peak one cycle non-repetitive surge current at 25 °C	l=	5 μs sine or 3 μs rect. pulse	or 3 μs rect. pulse Following any rated 1	190	Α
	IFSM	10 ms sine or 6 ms rect. pulse rated V _{RRM} applied	10		
Non-repetitive avalanche energy	E _{AS}	$T_J = 25 ^{\circ}\text{C}, I_{AS} = 2.0 \text{A}, L = 5.0 \text{mH}$		5	mJ
Repetitive avalanche current	I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _R typical		0.5	Α

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS		TYP.	MAX.	UNITS
Maximum forward voltage drop See fig. 1		0.5 A	T _{.1} = 25 °C	0.48	0.52	- V
	V _{FM} ⁽¹⁾	1 A	1j=25 C	0.54	0.58	
	V FM ('')	0.5 A	T _ 105 °C	0.38 0.4	0.42	
		1 A	T _J = 125 °C	0.46	0.50	
			V _R = Rated V _R	1	10	
		T _J = 25 °C	V _R = 20 V	0.2	0.5	- - μΑ
			V _R = 10 V	0.08	0.25	
Maximum reverse	1 (1)		V _R = 5 V	0.05	0.15	
leakage current See fig. 2	I _{RM} ⁽¹⁾		V _R = Rated V _R	0.5	2	
3		T 105 °C	V _R = 20 V	0.2	1	mA
		T _J = 125 °C	V _R = 10 V	0.15	0.8	
			V _R = 5 V	0.125	0.5	
Maximum junction capacitance	C _T	$V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz) 25 °C		-	90	pF
Maximum voltage rate of charge dV/dt Rated V _R		-	10 000	V/µs		

Note

 $^{^{(1)}\,}$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range	T _J ⁽¹⁾ , T _{Stg}		- 55 to 150	°C
Typical thermal resistance, junction to PCB	R _{thJL} (2)	DC operation	35	°C/W
Maximum thermal resistance, junction to ambient	R _{thJA}		150	- C/VV

Notes

(1) $\frac{dP_{tot}}{dT_J} < \frac{1}{R_{th,JA}}$ thermal runaway condition for a diode on its own heatsink

⁽²⁾ Mounted on minimum footprint PCB



10 000

1000

100

10

0.1

0.01

I_R - Reverse Current (µA)

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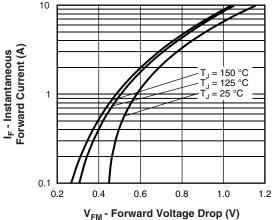


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)



= 150 °C

100

= 75 °C

T₁ = 25 °C

30 35 40

25

V_R - Reverse Voltage (V)
Fig. 2 - Typical Values of Reverse Current vs.
Reverse Voltage (Per Leg)

10 15 20

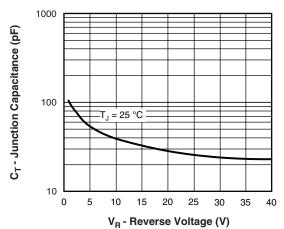


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

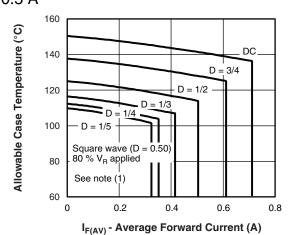


Fig. 4 - Maximum Allowable Case Temperature vs.
Average Forward Current (Per Leg)

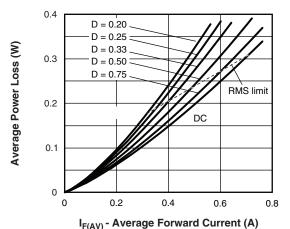
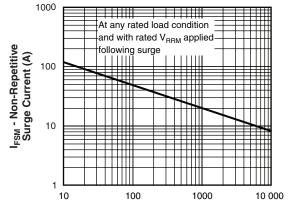


Fig. 5 - Forward Power Loss Characteristics (Per Leg)



t_p - Square Wave Pulse Duration (μs)

Fig. 6 - Maximum Non-Repetitive Surge Current (Per Leg)

Note

(1) Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{th,JC}$; $Pd = Forward power loss = I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6); $Pd_{REV} = Inverse$ power loss = $V_{R1} \times I_{R}$ (1 - D); I_{R} at 80 % V_{R} applied

FCSP05H40TR

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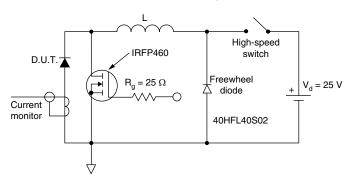


Fig. 7 - Unclamped Inductive Test Circuit

LINKS TO RELATED DOCUMENTS			
Dimensions	http://www.vishay.com/doc?95049		
Part marking information	http://www.vishay.com/doc?95060		
Packaging information	http://www.vishay.com/doc?95062		
SPICE model	http://www.vishay.com/doc?95318		

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